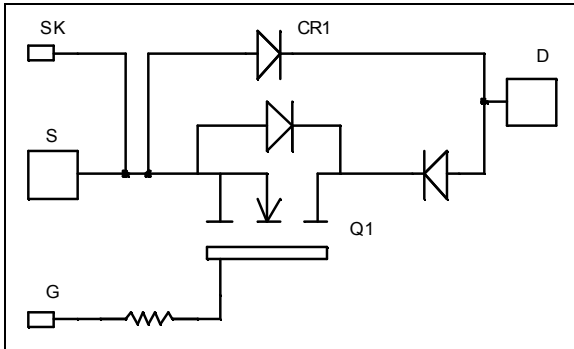


*Single switch  
Series & parallel diodes  
MOSFET Power Module*

**$V_{DSS} = 1000V$   
 $R_{DSon} = 65m\Omega$  typ @  $T_j = 25^\circ C$   
 $I_D = 145A$  @  $T_c = 25^\circ C$**

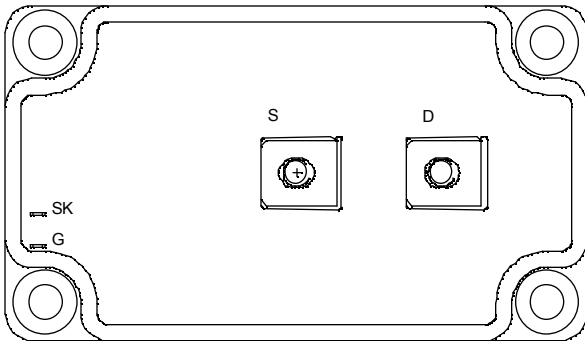


**Application**

- Welding converters
- Switched Mode Power Supplies
- Uninterruptible Power Supplies
- Motor control

**Features**

- Power MOS 7<sup>®</sup> MOSFETs
  - Low  $R_{DSon}$
  - Low input and Miller capacitance
  - Low gate charge
  - Avalanche energy rated
  - Very rugged
- Kelvin source for easy drive
- Very low stray inductance
  - Symmetrical design
  - M5 power connectors
- High level of integration
- AlN substrate for improved thermal performance



**Benefits**

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Low profile

**Absolute maximum ratings**

Symbol	Parameter	Max ratings	Unit
$V_{DSS}$	Drain - Source Breakdown Voltage	1000	V
$I_D$	Continuous Drain Current	$T_c = 25^\circ C$	145
		$T_c = 80^\circ C$	110
$I_{DM}$	Pulsed Drain current	580	A
$V_{GS}$	Gate - Source Voltage	$\pm 30$	V
$R_{DSon}$	Drain - Source ON Resistance	78	$m\Omega$
$P_D$	Maximum Power Dissipation	$T_c = 25^\circ C$	3250
$I_{AR}$	Avalanche current (repetitive and non repetitive)	30	A
$E_{AR}$	Repetitive Avalanche Energy	50	mJ
$E_{AS}$	Single Pulse Avalanche Energy	3200	

**CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

All ratings @  $T_j = 25^\circ\text{C}$  unless otherwise specified

**Electrical Characteristics**

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{GS} = 0\text{V}, V_{DS} = 1000\text{V}$   $T_j = 25^\circ\text{C}$			400	$\mu\text{A}$
		$V_{GS} = 0\text{V}, V_{DS} = 800\text{V}$   $T_j = 125^\circ\text{C}$			2	$\text{mA}$
$R_{DS(on)}$	Drain – Source on Resistance	$V_{GS} = 10\text{V}, I_D = 72.5\text{A}$		65	78	$\text{m}\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 20\text{mA}$	3		5	V
$I_{GSS}$	Gate – Source Leakage Current	$V_{GS} = \pm 30\text{V}, V_{DS} = 0\text{V}$			$\pm 400$	$\text{nA}$

**Dynamic Characteristics**

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
$C_{iss}$	Input Capacitance	$V_{GS} = 0\text{V}$ $V_{DS} = 25\text{V}$ $f = 1\text{MHz}$		28.5		$\text{nF}$
$C_{oss}$	Output Capacitance			5.08		
$C_{rss}$	Reverse Transfer Capacitance			0.9		
$Q_g$	Total gate Charge	$V_{GS} = 10\text{V}$ $V_{Bus} = 500\text{V}$ $I_D = 145\text{A}$		1068		$\text{nC}$
$Q_{gs}$	Gate – Source Charge			136		
$Q_{gd}$	Gate – Drain Charge			692		
$T_{d(on)}$	Turn-on Delay Time	$V_{GS} = 15\text{V}$ $V_{Bus} = 500\text{V}$ $I_D = 145\text{A}$ $R_G = 0.75\Omega$		18		$\text{ns}$
$T_r$	Rise Time			14		
$T_{d(off)}$	Turn-off Delay Time			140		
$T_f$	Fall Time			55		
$E_{on}$	Turn-on Switching Energy ①	<b>Inductive switching @ <math>25^\circ\text{C}</math></b> $V_{GS} = 15\text{V}, V_{Bus} = 670\text{V}$ $I_D = 145\text{A}, R_G = 0.75\Omega$		4.8		$\text{mJ}$
$E_{off}$	Turn-off Switching Energy			2.9		
$E_{on}$	Turn-on Switching Energy ①	<b>Inductive switching @ <math>125^\circ\text{C}</math></b> $V_{GS} = 15\text{V}, V_{Bus} = 670\text{V}$ $I_D = 145\text{A}, R_G = 0.75\Omega$		8		$\text{mJ}$
$E_{off}$	Turn-off Switching Energy			3.9		

①  $E_{on}$  includes diode reverse recovery

**Series diode ratings and characteristics**

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
$V_{RRM}$	Maximum Peak Repetitive Reverse Voltage		200			V
$I_{RM}$	Maximum Reverse Leakage Current	$V_R = 200\text{V}$	$T_j = 25^\circ\text{C}$		350	$\mu\text{A}$
			$T_j = 125^\circ\text{C}$		600	
$I_{F(AV)}$	Maximum Average Forward Current	50% duty cycle   $T_c = 80^\circ\text{C}$		120		A
$V_F$	Diode Forward Voltage	$I_F = 120\text{A}$		1.1	1.15	V
		$I_F = 240\text{A}$		1.4		
		$I_F = 120\text{A}$   $T_j = 125^\circ\text{C}$		0.9		
$t_{rr}$	Reverse Recovery Time	$I_F = 120\text{A}$ $V_R = 133\text{V}$ $di/dt = 400\text{A}/\mu\text{s}$	$T_j = 25^\circ\text{C}$		31	$\text{ns}$
			$T_j = 125^\circ\text{C}$		60	
$Q_{rr}$	Reverse Recovery Charge	$I_F = 120\text{A}$ $V_R = 133\text{V}$ $di/dt = 400\text{A}/\mu\text{s}$	$T_j = 25^\circ\text{C}$		120	$\text{nC}$
			$T_j = 125^\circ\text{C}$		500	

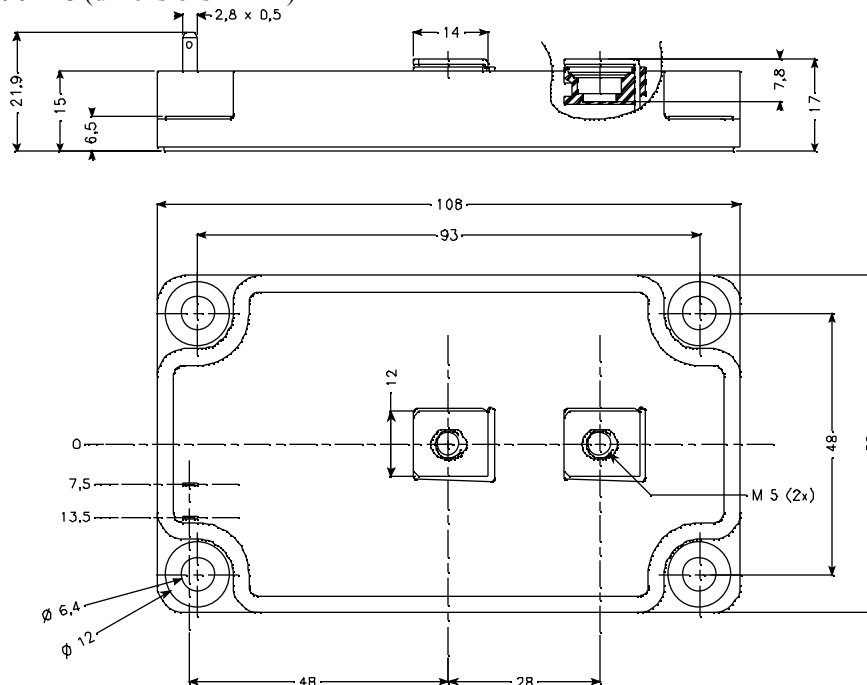
**Parallel diode ratings and characteristics**

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
V <sub>RRM</sub>	Maximum Peak Repetitive Reverse Voltage			1000			V
I <sub>RM</sub>	Maximum Reverse Leakage Current	V <sub>R</sub> =1000V	T <sub>j</sub> = 25°C			750	μA
			T <sub>j</sub> = 125°C			1000	
I <sub>F(AV)</sub>	Maximum Average Forward Current	50% duty cycle	T <sub>c</sub> = 80°C		240		A
V <sub>F</sub>	Diode Forward Voltage	I <sub>F</sub> = 240A			2	2.5	V
		I <sub>F</sub> = 480A			2.2		
		I <sub>F</sub> = 240A	T <sub>j</sub> = 125°C		1.7		
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 240A V <sub>R</sub> = 667V di/dt = 800A/μs	T <sub>j</sub> = 25°C		280		ns
	T <sub>j</sub> = 125°C			350			
	T <sub>j</sub> = 25°C			3.04			
Q <sub>rr</sub>	Reverse Recovery Charge		T <sub>j</sub> = 125°C		14.4		μC

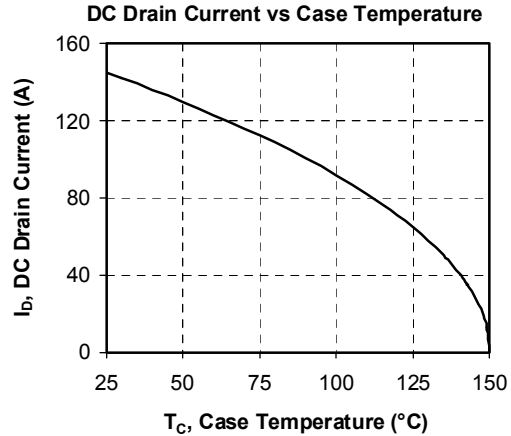
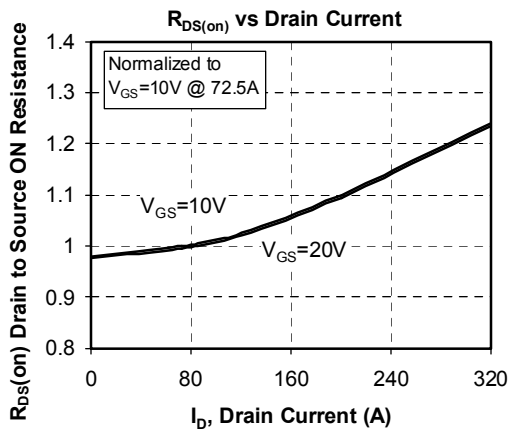
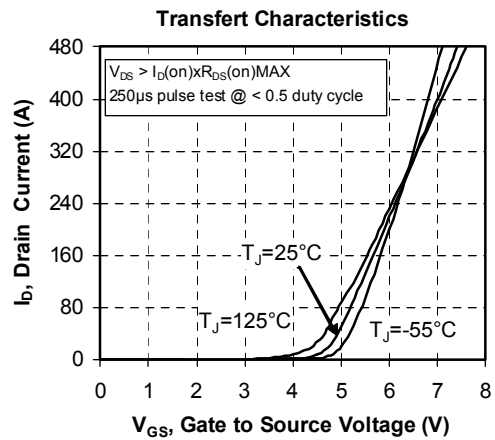
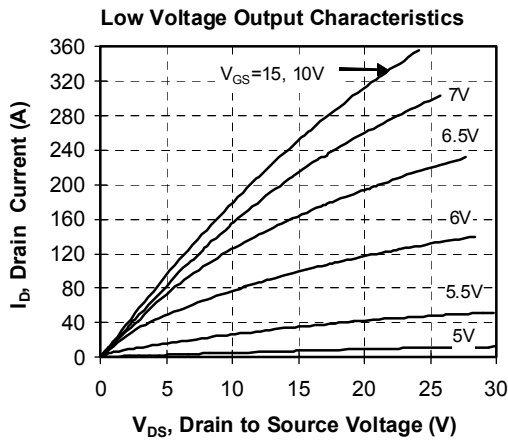
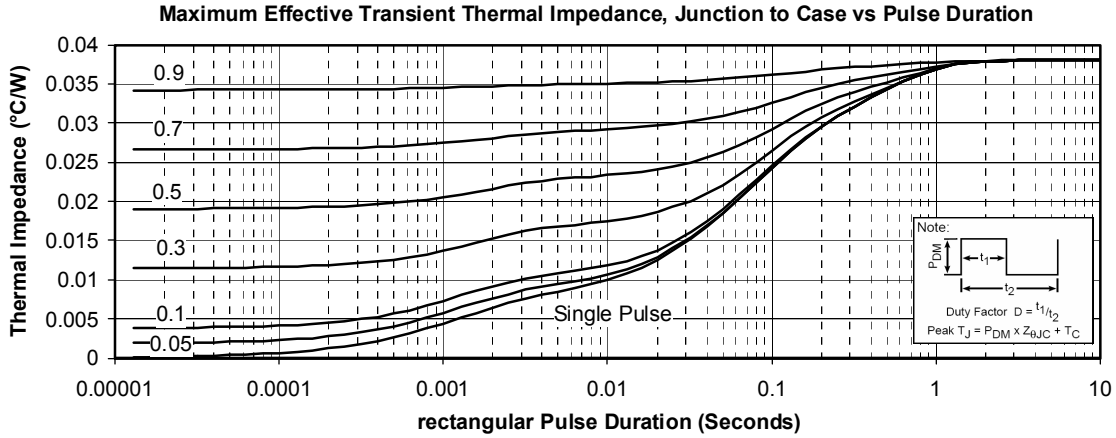
**Thermal and package characteristics**

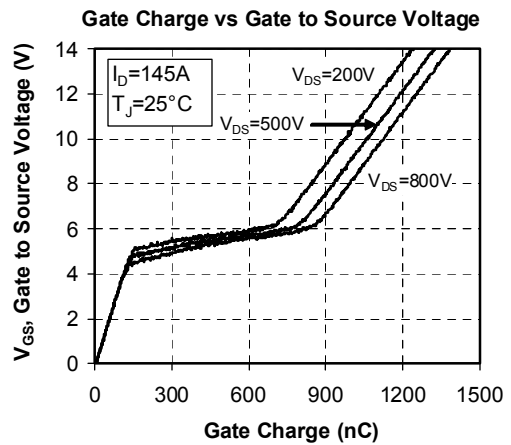
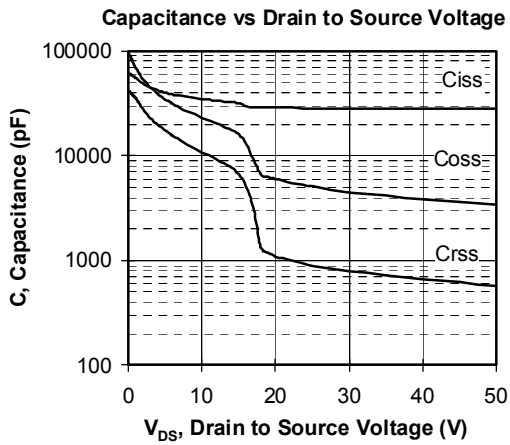
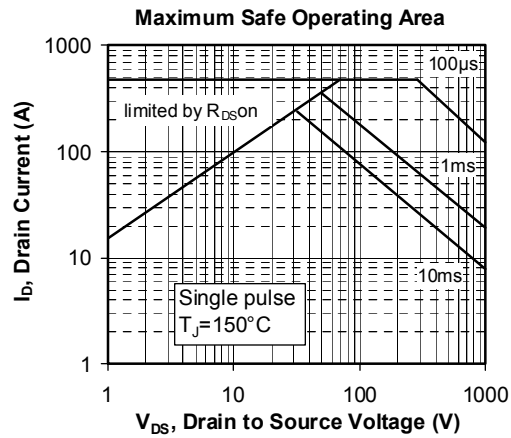
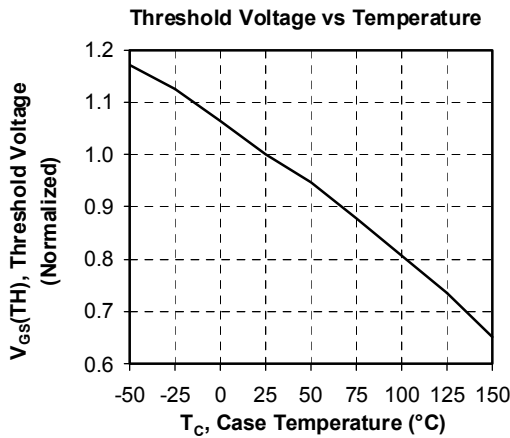
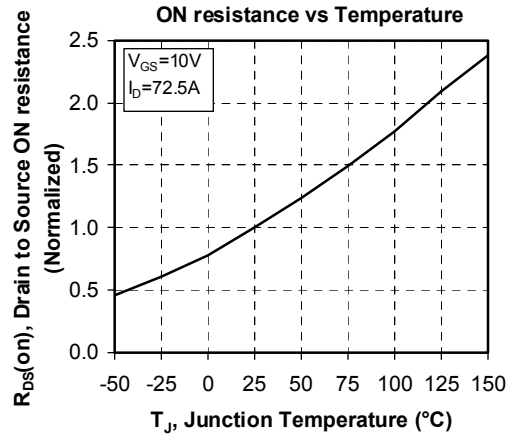
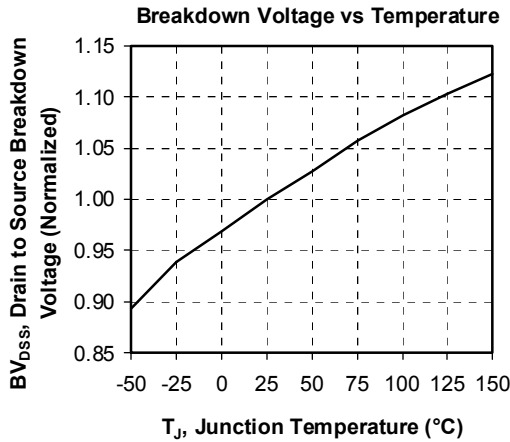
Symbol	Characteristic			Min	Typ	Max	Unit
R <sub>thJC</sub>	Junction to Case	Transistor				0.038	°C/W
		Series diode				0.46	
		Parallel diode				0.23	
V <sub>ISOL</sub>	RMS Isolation Voltage, any terminal to case t = 1 min, I <sub>sol</sub> < 1mA, 50/60Hz			2500			V
T <sub>J</sub>	Operating junction temperature range			-40		150	°C
T <sub>STG</sub>	Storage Temperature Range			-40		125	
T <sub>C</sub>	Operating Case Temperature			-40		100	
Torque	Mounting torque	To Heatsink	M6	3		5	N.m
		For terminals	M5	2		3.5	
Wt	Package Weight					280	g

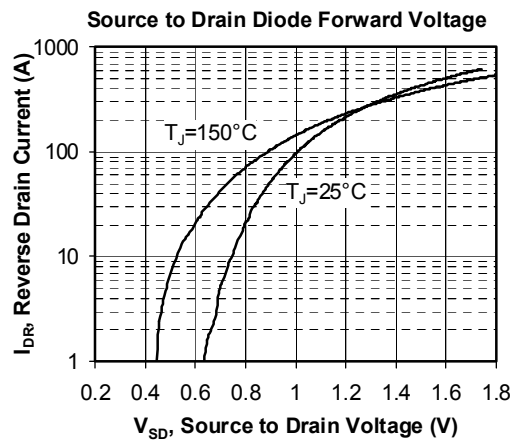
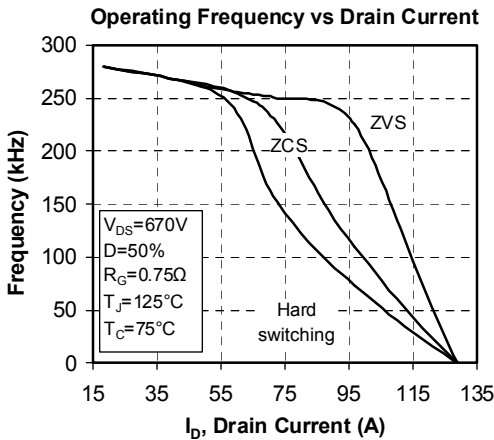
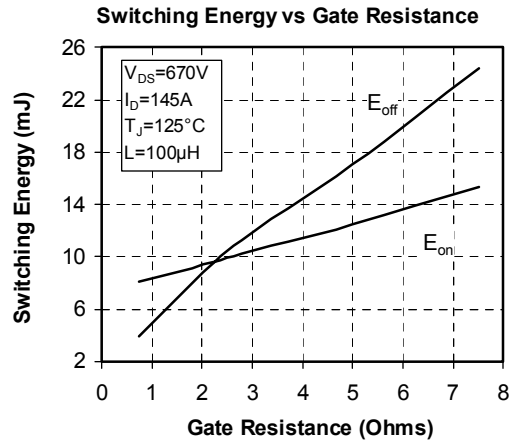
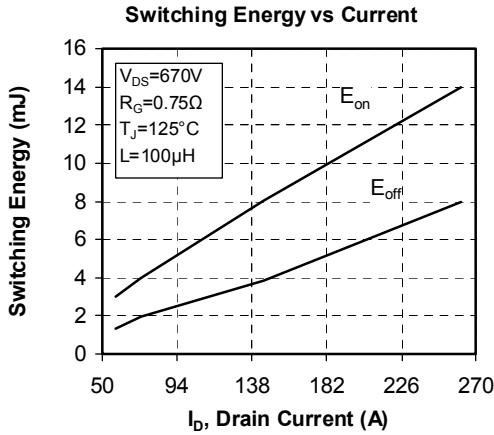
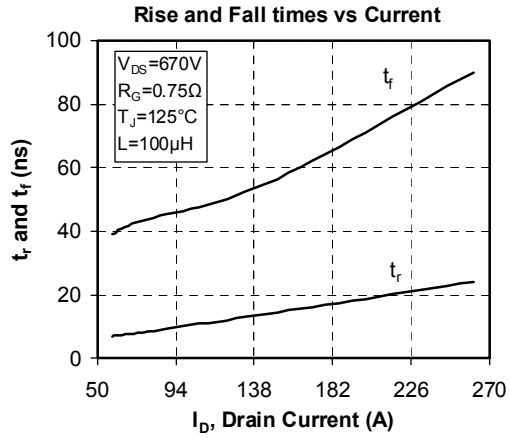
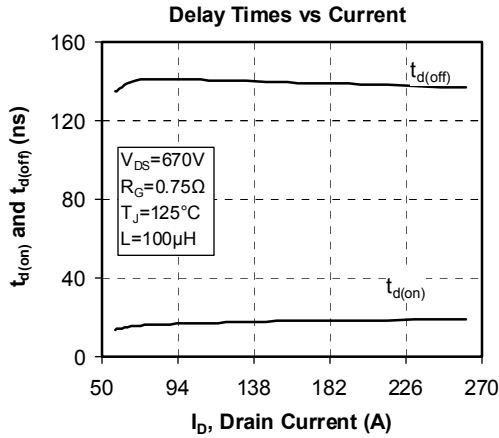
**SP6 Package outline (dimensions in mm)**



**Typical Performance Curve**







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